

# 2026 2<sup>nd</sup> Asia Conference on Communications and 6G ACC6G 2026

May 15-17, 2026 | Shenzhen, China

2026 2<sup>nd</sup> Asia Conference on Communications and 6G (ACC6G 2026) is organized by Southern University of Science and Technology, technically sponsored by Auckland University of Technology, supported by Sichuan University, Southeast University, Asia Pacific Institute of Science and Engineering(APISE) and Hong Kong Association for Advanced Scientific Research(HKAASR), and media supported by *Radio Communications Technology, Radio Engineering, MOBILE COMMUNICATIONS, Communications Technology*, 6G Standards and Technological Exploration, will be held in Shenzhen, China from May 15 to 17, 2026.

## Topics

ACC6G 2026 solicits researchers in academia and industry to submit papers on a wide range of research subjects, encompassing theoretical and applied research. Original technical papers are sought, but are not limited, to the following areas:

- Track 1: 6G Network Architecture and Key Technologies
- Track 2: High-Frequency Wireless Transmission and Devices
- Track 3: Integrated Sensing and Communication
- Track 4: Integration of Communication and AI
- Track 5: New Technologies for 6G and Future Communication
- Track 6: Space-Air-Ground-Sea Integration Communication
- Track 7: Security and Privacy of 6G
- Track 8: Green Communication and Energy-Aware Networks

# Special Seesions

Physical Layer Security (PLS) Communications for 6G Wireless Networks

The special session will be kept updating...

## Important Dates

Submission Deadline: **Jan. 15, 2026**Notification of Acceptance: Feb.15, 2026
Registration Deadline: Mar. 15, 2026

### Submission

Authors can submit their manuscripts in Word/PDF through email: info@acc6g.org

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